



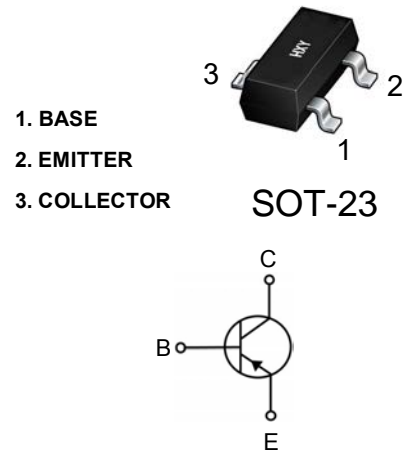
## Features

- Ideally suited for automatic insertion
- For switching and AF amplifier applications

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HSBC846BLT3G	SOT-23	1x	3000

x: BC846B=B



## Maxmim Ratings (Ta=25 unless otherwise noted)

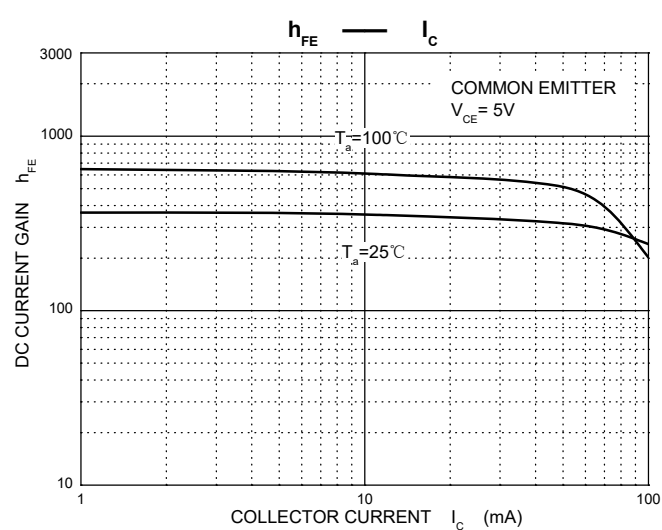
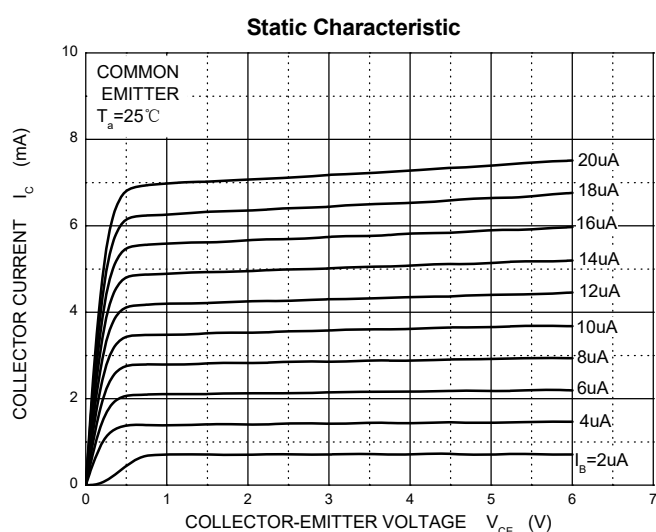
Symbol	Parameter	Limit	Unit
$V_{CBO}$	Collector-Base Voltage	80	V
$V_{CEO}$	Collector-Emitter Voltage	65	V
$V_{EBO}$	Emitter-Base Voltage	6	V
$I_C$	Collector Current	100	mA
$P_C$	Collector Power Dissipation	200	mW
$R_{\theta JA}$	Thermal Resistance From Junction To Ambient	625	$^{\circ}C/W$
$T_J$	Junction Temperature	150	$^{\circ}C$
$T_{stg}$	Storage Temperature	-55~+150	$^{\circ}C$

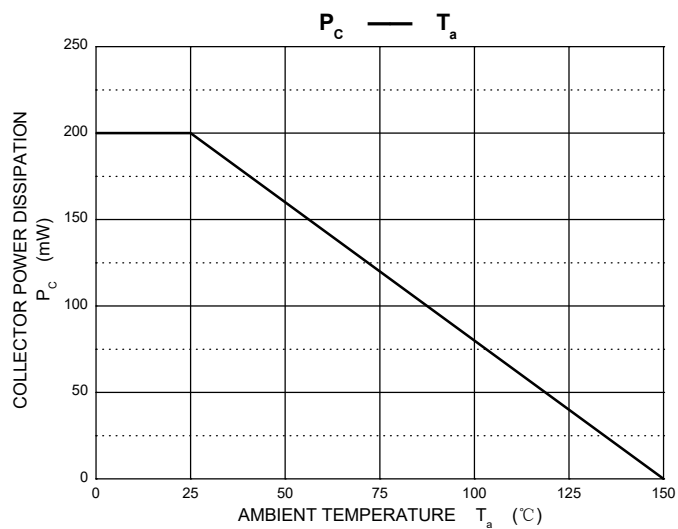
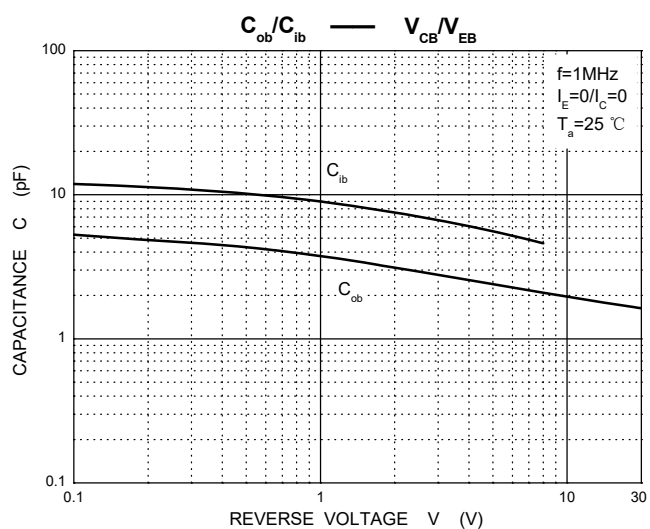
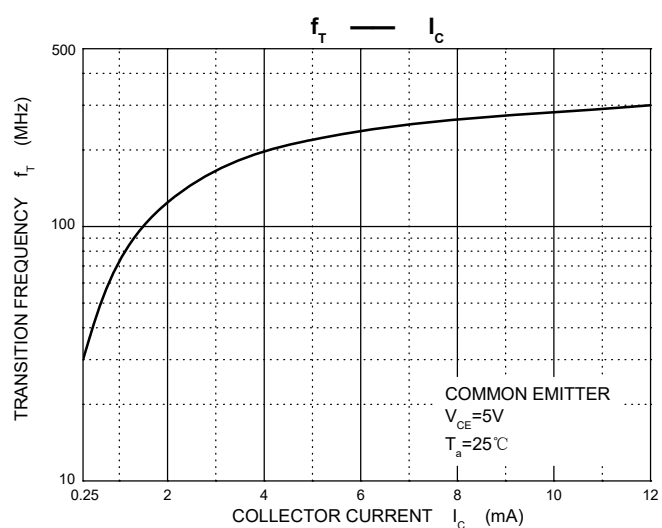
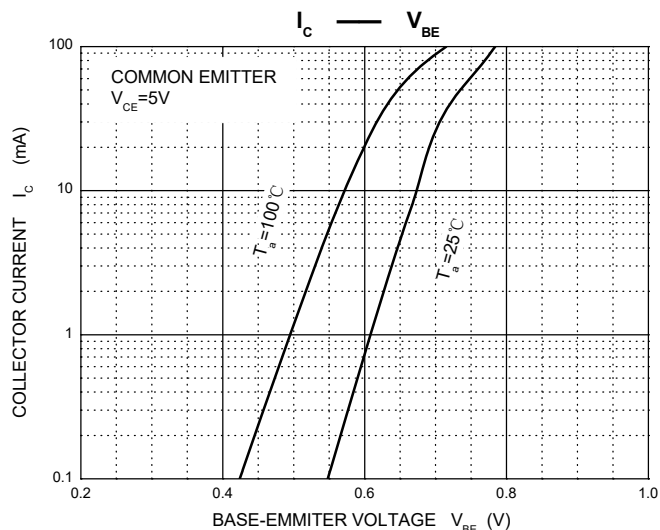
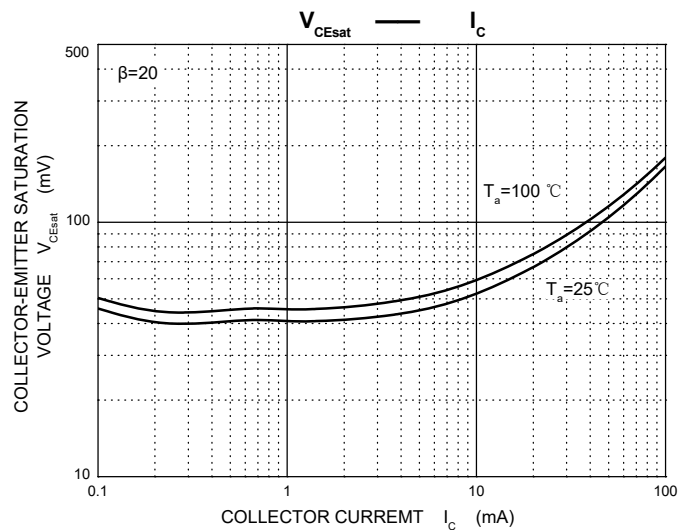
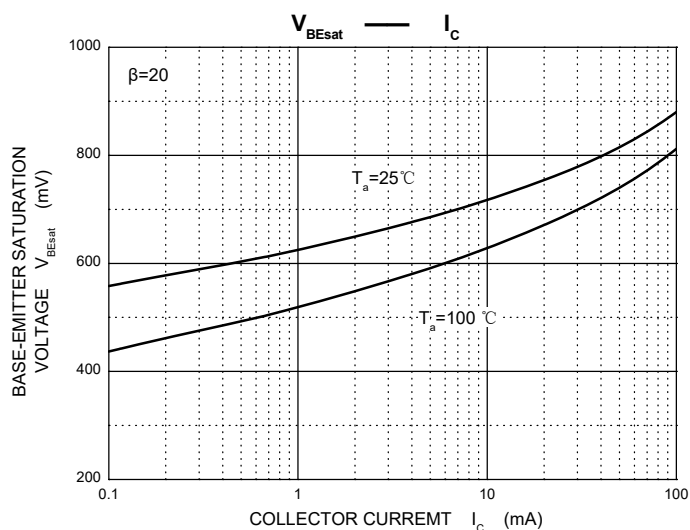


### Electrcal Charcteristics (Ta=25 unless otherwise specified)

Symbol	Parameter	Test conditions	Min	Max	Unit
$V_{(BR)CBO}$	Collector-base breakdown voltage	$I_C=10\mu A, I_E=0$	80		V
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C=10mA, I_B=0$	65		V
$V_{(BR)EBO}$	Emitter-base breakdown voltage	$I_E=10\mu A, I_C=0$	6		V
$I_{CBO}$	Collector cut-off current	$V_{CB}=70V, I_E=0$		100	nA
$I_{EBO}$	Emitter cut-off current	$V_{EB}=5V, I_C=0$		100	nA
$h_{FE}$	DC current gain	$V_{CE}=5V, I_C=2mA$	200	450	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_C=100mA, I_B=5mA$		0.5	V
$V_{BE(sat)}$	Base-emitter saturation voltage			1.1	V
$f_T$	Transition frequency	$V_{CE}=5V, I_C=10mA, f=30MHz$	100		MHz
$C_{ob}$	Collector output capacitance	$V_{CB}=10V, f=1MHz$		4.5	pF

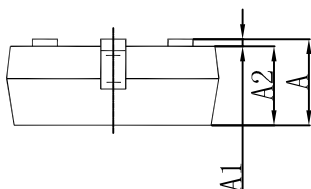
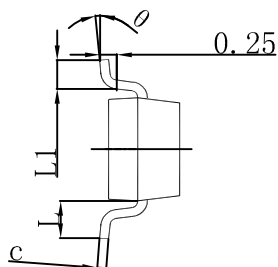
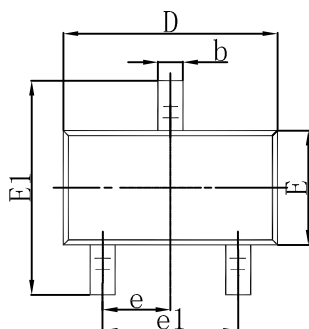
### Typical Characteristics





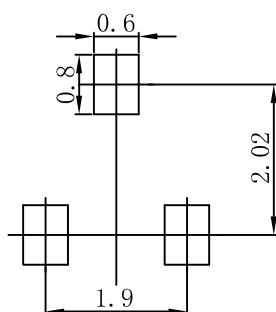


## SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

## SOT-23 Suggested Pad Layout



Note:  
1. Controlling dimension: in millimeters.  
2. General tolerance:  $\pm 0.05\text{mm}$ .  
3. The pad layout is for reference purposes only.



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